



New Product

Si7485DP
Vishay Siliconix

P-Channel 20-V (D-S) MOSFET

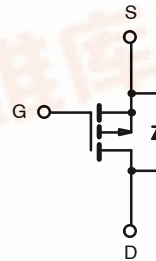
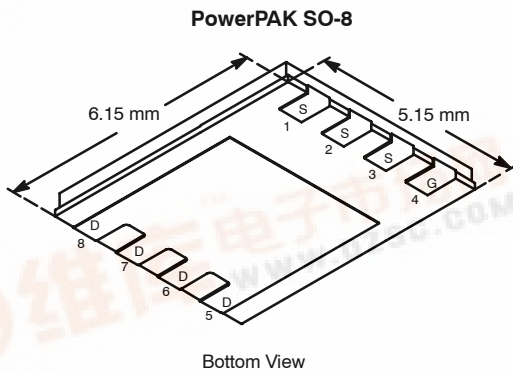
PRODUCT SUMMARY		
V _{DS} (V)	r _{DS(on)} (Ω)	I _D (A)
-20	0.0073 @ V _{GS} = -4.5 V	-20
	0.0090 @ V _{GS} = -2.5 V	-18
	0.013 @ V _{GS} = -1.8 V	-15

FEATURES

- TrenchFET® Power MOSFET
- New Low Thermal Resistance PowerPAK® Package with Low 1.07-mm Profile

APPLICATIONS

- Battery Switch for Portable Devices



P-Channel MOSFET

Ordering Information: Si7485DP-T1

ABSOLUTE MAXIMUM RATINGS (T _A = 25°C UNLESS OTHERWISE NOTED)					
Parameter	Symbol	10 secs	Steady State	Unit	
Drain-Source Voltage	V _{DS}	-20		V	
Gate-Source Voltage	V _{GS}	±8			
Continuous Drain Current (T _J = 150°C) ^a	I _D	T _A = 25°C	-20	-12.5	A
		T _A = 70°C	-16.5	-9.5	
Pulsed Drain Current	I _{DM}	-50			
continuous Source Current (Diode Conduction) ^a	I _S	-4.5	-1.6		
Maximum Power Dissipation ^a	P _D	T _A = 25°C	5	1.8	W
		T _A = 70°C	3.2	1.1	
Operating Junction and Storage Temperature Range	T _J , T _{stg}	-55 to 150		°C	

THERMAL RESISTANCE RATINGS					
Parameter	Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^a	R _{thJA}	t ≤ 10 sec	20	25	°C/W
		Steady State	54	68	
Maximum Junction-to-Case (Drain)	R _{thJC}	1.7	2.2		

Notes:
a. Surface Mounted on 1" x 1" FR4 Board.

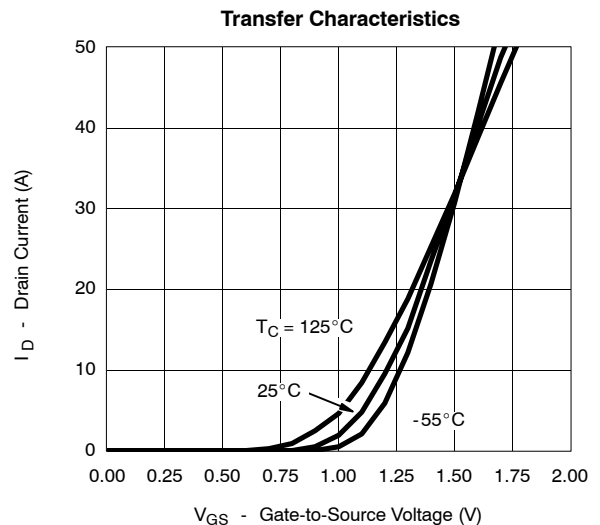
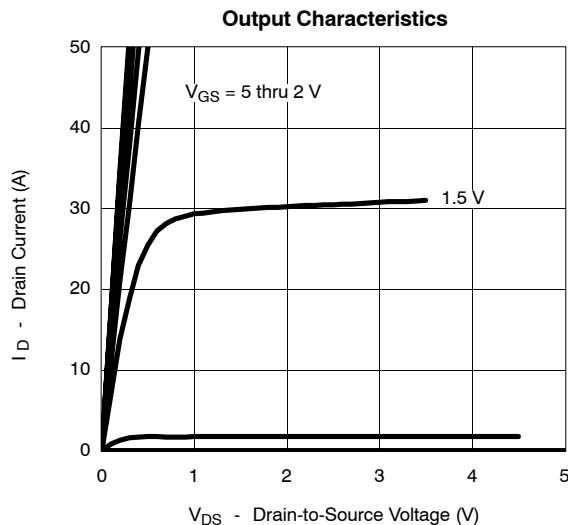


SPECIFICATIONS (T_J = 25 °C UNLESS OTHERWISE NOTED)						
Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Static						
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = -1 mA	-0.4		-0.9	V
Gate-Body Leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = ±8 V			±100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = -16 V, V _{GS} = 0 V			-1	μA
		V _{DS} = -16 V, V _{GS} = 0 V, T _J = 70 °C			-10	
On-State Drain Current ^a	I _{D(on)}	V _{DS} ≤ -5 V, V _{GS} = -4.5 V	-40			A
Drain-Source On-State Resistance ^a	r _{DS(on)}	V _{GS} = -4.5 V, I _D = -20 A		0.006	0.0073	Ω
		V _{GS} = -2.5 V, I _D = -18 A		0.0074	0.0090	
		V _{GS} = -1.8 V, I _D = -15 A		0.0106	0.013	
Forward Transconductance ^a	g _{fs}	V _{DS} = -15 V, I _D = -20 A		80		S
Diode Forward Voltage ^a	V _{SD}	I _S = -4.5 A, V _{GS} = 0 V		-0.62	-1.1	V
Dynamic^b						
Total Gate Charge	Q _g	V _{DS} = -10 V, V _{GS} = -5 V, I _D = -20 A		99	150	nC
Gate-Source Charge	Q _{gs}		11.5			
Gate-Drain Charge	Q _{gd}		29			
Gate-Resistance	R _G			2.4		Ω
Turn-On Delay Time	t _{d(on)}	V _{DD} = -10 V, R _L = 10 Ω I _D ≅ -1 A, V _{GEN} = -4.5 V, R _G = 6 Ω		80	120	ns
Rise Time	t _r		140	210		
Turn-Off Delay Time	t _{d(off)}		360	540		
Fall Time	t _f		170	260		
Source-Drain Reverse Recovery Time	t _{rr}	I _F = -2.9 A, di/dt = 100 A/μs		55	80	

Notes

- a. Pulse test; pulse width ≤ 300 μs, duty cycle ≤ 2%.
- b. Guaranteed by design, not subject to production testing.

TYPICAL CHARACTERISTICS (25 °C UNLESS NOTED)



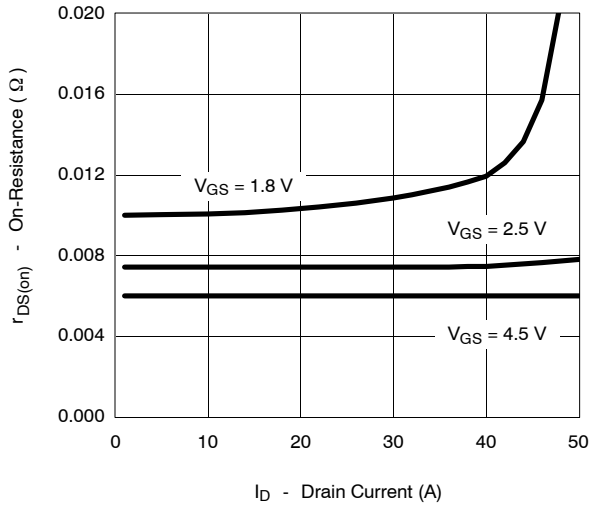


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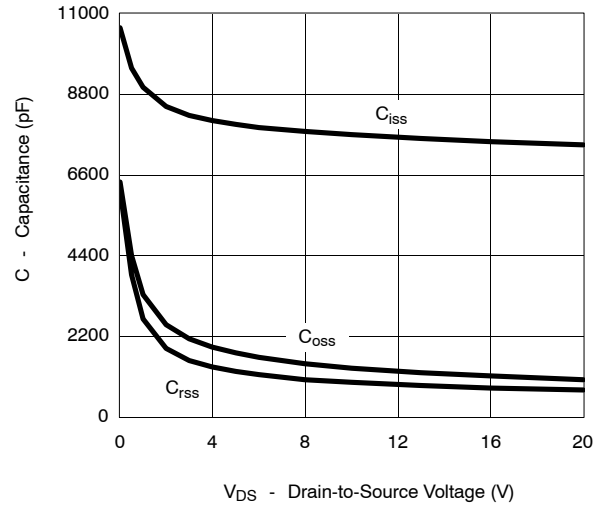
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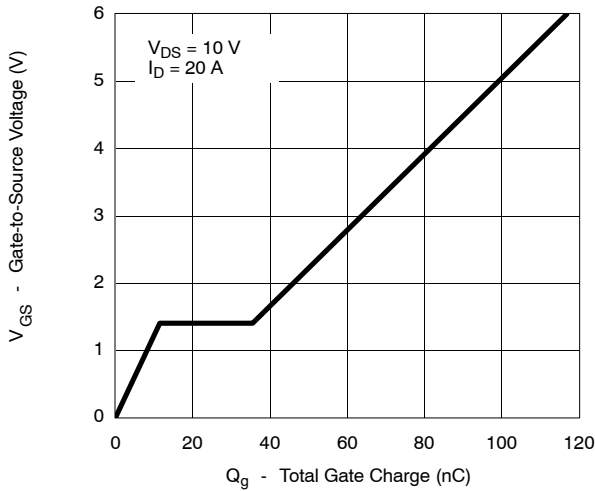
On-Resistance vs. Drain Current



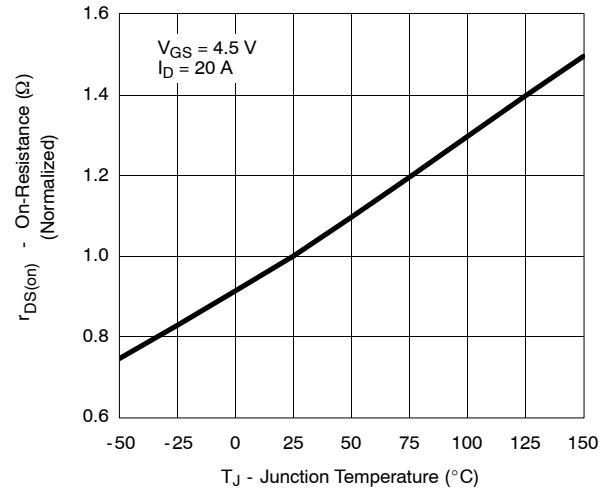
Capacitance



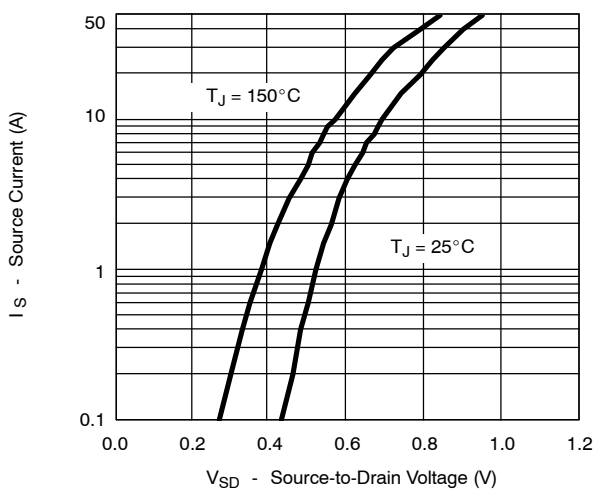
Gate Charge



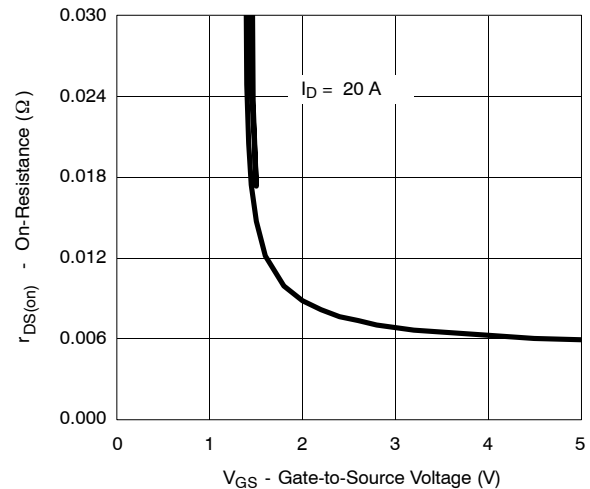
On-Resistance vs. Junction Temperature



Source-Drain Diode Forward Voltage

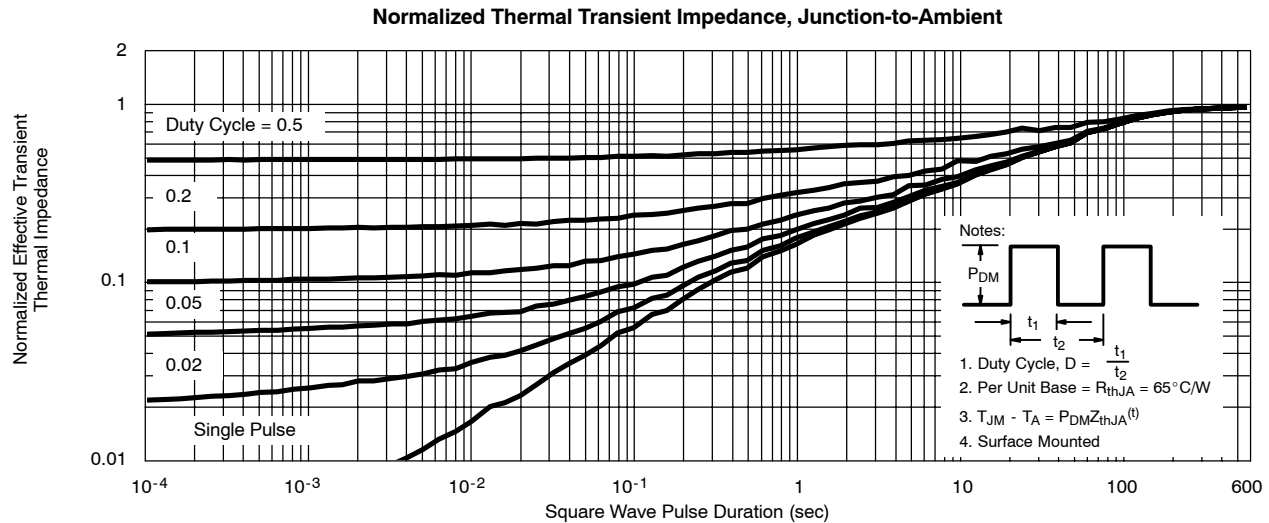
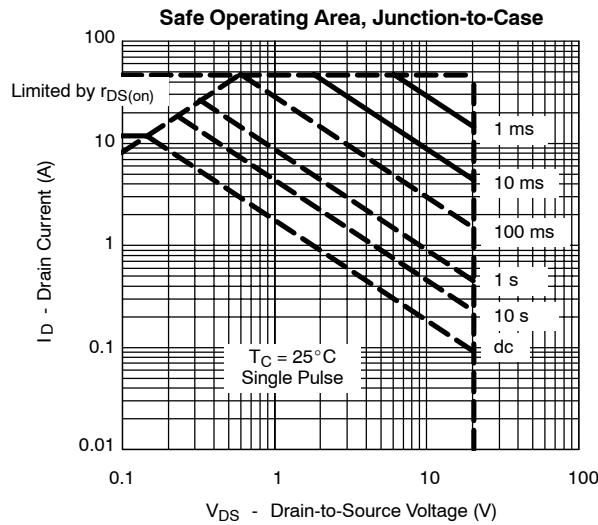
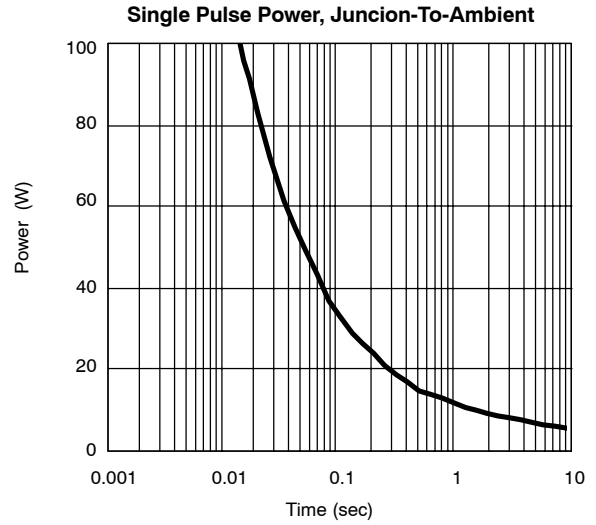
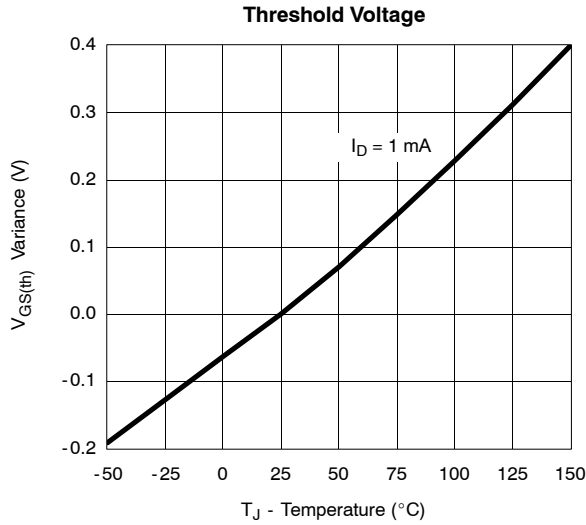


On-Resistance vs. Gate-to-Source Voltage





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